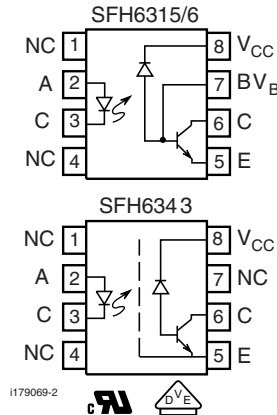
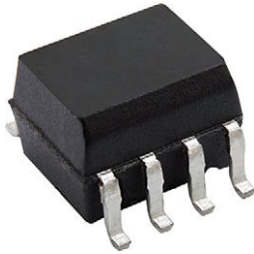


## High Speed Optocoupler, 1 MBd, Transistor Output



### FEATURES

- Surface mountable
- Compatible with infrared vapor phase reflow and wave soldering processes
- Isolation test voltage, 4000 V<sub>RMS</sub>
- Very high common mode transient immunity: 15000 V/μs at V<sub>CM</sub> = 1500 V guaranteed (SFH6343)
- High speed: 1 MBd
- Guaranteed AC and DC performance temperature: 0 °C to 70 °C
- Open collector output
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

### LINKS TO ADDITIONAL RESOURCES



### DESCRIPTION

The SFH6315, SFH6316, SFH6343, high speed optocouplers, each consists of a GaAlAs infrared emitting diode, optically coupled with an integrated photo detector and a high speed transistor. The photo detector is junction isolated from the transistor to reduce miller capacitance effects. The open collector output function allows circuit designers to adjust the load conditions when interfacing with different logic systems such as TTL, CMOS, etc.

Because the SFH6343 has a faraday shield on the detector chip, it can also reject and minimize high input to output common mode transient voltages. The SFH6343 provides an isolated base connection to further reduce the potential electrical noise entering the package.

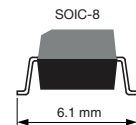
### APPLICATIONS

- Microprocessor system interface
- Ground loop elimination
- Galvanic noise isolation
- Serial bus systems
- Signal level translation

### AGENCY APPROVALS

- [UL1577](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884\) available with option 1](#)
- [CSA](#)

ORDERING INFORMATION			
S	F	H	6 3 # # T
PART NUMBER			
AGENCY CERTIFIED / PACKAGE		CTR (%)	
UL, cUL, CSA		≥ 5	≥ 15
SOIC-8		SFH6315T	SFH6316T
		<b>NO BASE CONNECTION</b>	
		SFH6343T	





<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
Reverse voltage		$V_R$	3	V
DC forward current		$I_F$	25	mA
Surge forward current	$t_p \leq 1\text{ }\mu\text{s}$ , 300 pulses/s	$I_{FSM}$	1	A
Power dissipation	$T_{amb} \leq 70\text{ }^{\circ}\text{C}$	$P_{diss}$	45	mW
<b>OUTPUT</b>				
Supply voltage		$V_S$	-0.5 to 30	V
Output voltage		$V_O$	-0.5 to 25	V
Output current		$I_O$	8	mA
Power dissipation	$T_{amb} \leq 70\text{ }^{\circ}\text{C}$	$P_{diss}$	100	mW
<b>COUPLER</b>				
Storage temperature range		$T_{stg}$	-55 to +150	$^{\circ}\text{C}$
Ambient temperature range		$T_{amb}$	-55 to +100	$^{\circ}\text{C}$
Junction temperature		$T_j$	125	$^{\circ}\text{C}$
Soldering temperature	Max. 10 s, dip soldering distance to seating plane $\geq 1.5\text{ mm}$		260	$^{\circ}\text{C}$

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

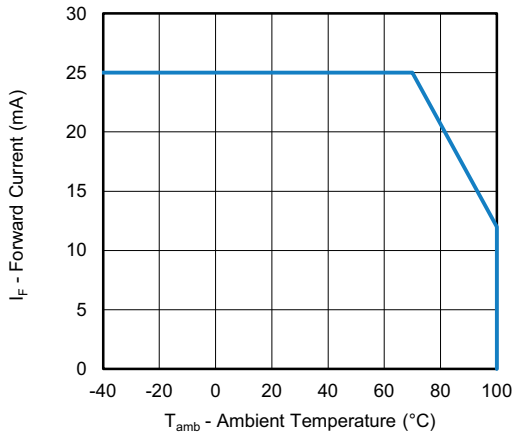


Fig. 1 - Forward Current vs. Ambient Temperature

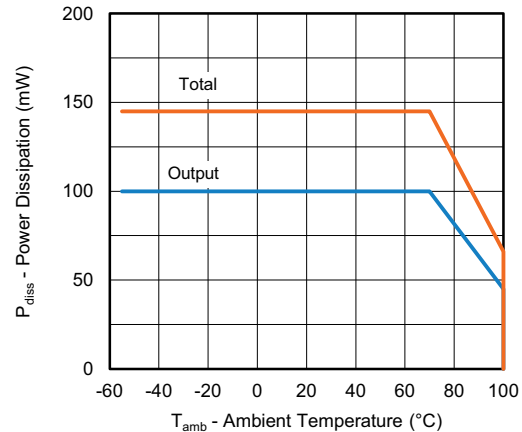


Fig. 2 - Power Dissipation vs. Ambient Temperature



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$ ; typical values are at $T_{amb} = 25\text{ }^{\circ}\text{C}$ )							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>							
Forward voltage	$I_F = 16\text{ mA}$ <sup>(1)</sup>		$V_F$	-	1.3	1.8	V
	$I_F = 16\text{ mA}$		$V_F$	-	1.3	1.9	V
Reverse current	$V_R = 3\text{ V}$		$I_R$	-	0.001	10	$\mu\text{A}$
Capacitance	$f = 1\text{ MHz}$ , $V_F = 0\text{ V}$		$C_{IN}$	-	24	-	pF
Temperature coefficient of forward voltage	$I_F = 16\text{ mA}$		$\Delta V_F / \Delta T_{amb}$	-	-1.7	-	mW/ $^{\circ}\text{C}$
<b>OUTPUT</b>							
Logic low supply current	$I_F = 16\text{ mA}$ , $V_O = \text{open}$ , $V_{CC} = 15\text{ V}$		$I_{CCL}$	-	215	-	$\mu\text{A}$
Logic high supply current	$I_F = 0\text{ mA}$ , $V_O = \text{open}$ , $V_{CC} = 15\text{ V}$ <sup>(1)</sup>		$I_{CCH}$	-	0.1	1	$\mu\text{A}$
	$I_F = 0\text{ mA}$ , $V_O = \text{open}$ , $V_{CC} = 15\text{ V}$		$I_{CCH}$	-	0.1	2	$\mu\text{A}$
Logic low output voltage	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $I_O = 1.1\text{ mA}$ <sup>(1)</sup>	SFH6315	$V_{OL}$	-	0.15	0.4	V
	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $I_O = 0.8\text{ mA}$		$V_{OL}$	-	0.13	0.5	V
	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $I_O = 3\text{ mA}$ <sup>(1)</sup>	SFH6316	$V_{OL}$	-	0.25	0.4	V
	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $I_O = 2.4\text{ mA}$		$V_{OL}$	-	0.22	0.5	V
	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $I_O = 3.0\text{ mA}$ <sup>(1)</sup>	SFH6343	$V_{OL}$	-	0.25	0.4	V
	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $I_O = 2.4\text{ mA}$		$V_{OL}$	-	0.22	0.5	V
Logic high output current	$I_F = 0\text{ mA}$ , $V_O = V_{CC} = 5.5\text{ V}$ <sup>(1)</sup>		$I_{OH}$	-	0.003	0.5	$\mu\text{A}$
	$I_F = 0\text{ mA}$ , $V_O = V_{CC} = 15\text{ V}$ <sup>(1)</sup>		$I_{OH}$	-	0.01	1	$\mu\text{A}$
	$I_F = 0\text{ mA}$ , $V_O = V_{CC} = 15\text{ V}$		$I_{OH}$	-	-	50	$\mu\text{A}$
<b>COUPLER</b>							
Capacitance (input to output) <sup>(2)</sup>	$f = 1\text{ MHz}$		$C_{IO}$	-	0.4	-	pF

**Notes**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements

(1)  $T_{amb} = 25\text{ }^{\circ}\text{C}$ (2) A 0.1  $\mu\text{F}$  bypass capacitor connected between pins 5 and 8 is recommended

<b>CURRENT TRANSFER RATIO</b> ( $T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$ ; typical values are at $T_{amb} = 25\text{ }^{\circ}\text{C}$ )							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 16\text{ mA}$ , $V_O = 0.4\text{ V}$ , $V_{CC} = 4.5\text{ V}$ <sup>(1)</sup>	SFH6315	CTR	7	28	50	%
	$I_F = 16\text{ mA}$ , $V_O = 0.5\text{ V}$ , $V_{CC} = 4.5\text{ V}$		CTR	5	29	-	%
	$I_F = 16\text{ mA}$ , $V_O = 0.4\text{ V}$ , $V_{CC} = 4.5\text{ V}$ <sup>(1)</sup>	SFH6316	CTR	19	28	50	%
	$I_F = 16\text{ mA}$ , $V_O = 0.5\text{ V}$ , $V_{CC} = 4.5\text{ V}$		CTR	15	29	-	%
	$I_F = 16\text{ mA}$ , $V_O = 0.4\text{ V}$ , $V_{CC} = 4.5\text{ V}$ <sup>(1)</sup>	SFH6343	CTR	19	28	50	%
	$I_F = 16\text{ mA}$ , $V_O = 0.5\text{ V}$ , $V_{CC} = 4.5\text{ V}$		CTR	15	29	-	%

**Notes**

- Current transfer ratio in percent equals the ratio of output collector current ( $I_O$ ) to the forward LED input current ( $I_F$ ) times 100. A 0.1  $\mu\text{F}$  bypass capacitor connected between pins 5 and 8 is recommended

(1)  $T_{amb} = 25\text{ }^{\circ}\text{C}$

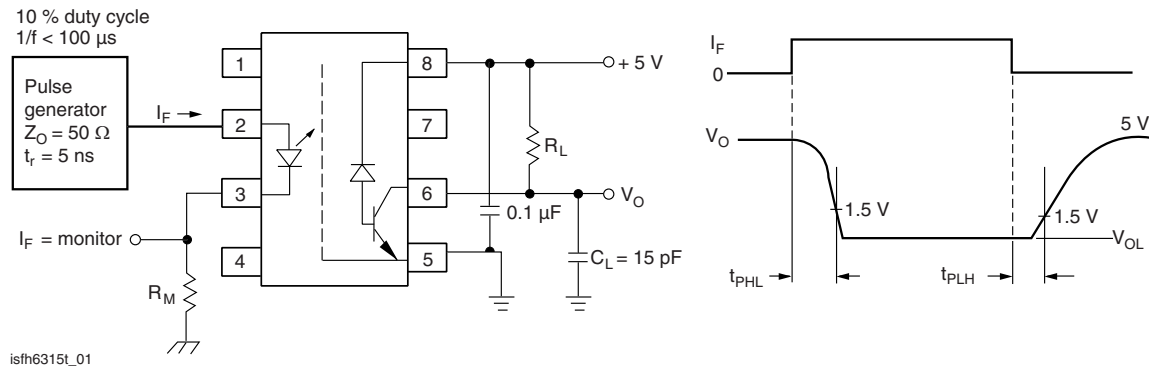


Fig. 3 - Test Circuit for Switching Times

SWITCHING CHARACTERISTICS							
$(T_{\text{amb}} = 0 \text{ }^\circ\text{C to } 70 \text{ }^\circ\text{C}, V_{\text{CC}} = 5 \text{ V}, I_F = 16 \text{ mA}; \text{ typical values are at } T_{\text{amb}} = 25 \text{ }^\circ\text{C})$							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Propagation delay time to logic low at output (see Fig. 1)	$R_L = 4.1 \text{ k}\Omega$	SFH6315	$t_{PHL}^{(1)}$	-	0.5	1.5	$\mu\text{s}$
			$t_{PHL}$	-	0.5	2	$\mu\text{s}$
	$R_L = 1.9 \text{ k}\Omega$	SFH6316, SFH6343	$t_{PHL}^{(1)}$	-	0.6	0.8	$\mu\text{s}$
			$t_{PHL}$	-	0.6	1	$\mu\text{s}$
Propagation delay time to logic high at output (see Fig. 1)	$R_L = 4.1 \text{ k}\Omega$	SFH6315	$t_{PLH}^{(1)}$	-	0.7	1.5	$\mu\text{s}$
			$t_{PLH}$	-	0.7	2	$\mu\text{s}$
	$R_L = 1.9 \text{ k}\Omega$	SFH6316, SFH6343	$t_{PLH}^{(1)}$	-	0.3	0.8	$\mu\text{s}$
			$t_{PLH}$	-	0.3	1	$\mu\text{s}$

**Notes**

- The 1.9 k $\Omega$  load represents 1 TTL unit load of 1.6 mA and the 5.6 k $\Omega$  pull-up resistor.  
 The 4.1 k $\Omega$  load represents 1 LSTTL unit load of 0.36 mA and the 6.1 k $\Omega$  pull-up resistor
- <sup>(1)</sup>  $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

COMMON MODE TRANSIENT IMMUNITY ( $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ )							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode transient immunity at logic high level output (see Fig. 2)	$R_L = 4.1 \text{ k}\Omega, I_F = 0 \text{ mA}, V_{\text{CM}} = 10 \text{ V}_{\text{PP}}$	SFH6315	$ CM_H $	-	1000	-	$\text{V}/\mu\text{s}$
	$R_L = 1.9 \text{ k}\Omega, I_F = 0 \text{ mA}, V_{\text{CM}} = 10 \text{ V}_{\text{PP}}$	SFH6316	$ CM_H $	-	1000	-	$\text{V}/\mu\text{s}$
	$R_L = 1.9 \text{ k}\Omega, I_F = 0 \text{ mA}, V_{\text{CM}} = 1500 \text{ V}_{\text{PP}}$	SFH6343	$ CM_H $	15 000	30 000	-	$\text{V}/\mu\text{s}$
Common mode transient immunity at logic low level output (see Fig. 2)	$R_L = 4.1 \text{ k}\Omega, I_F = 16 \text{ mA}, V_{\text{CM}} = 10 \text{ V}_{\text{PP}}$	SFH6315	$ CM_L $	-	1000	-	$\text{V}/\mu\text{s}$
	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, V_{\text{CM}} = 10 \text{ V}_{\text{PP}}$	SFH6316	$ CM_L $	-	1000	-	$\text{V}/\mu\text{s}$
	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, V_{\text{CM}} = 1500 \text{ V}_{\text{PP}}$	SFH6343	$ CM_L $	15 000	30 000	-	$\text{V}/\mu\text{s}$

**Note**

- Common mode transient immunity in a logic high level is the maximum tolerable (positive)  $dV_{\text{CM}}/dt$  on the leading edge of the common mode pulse ( $V_{\text{CM}}$ ) to assure that the output will remain in a logic high state (i.e.,  $V_O > 2 \text{ V}$ ). Common mode transient immunity in a logic low level is the maximum tolerable (negative)  $dV_{\text{CM}}/dt$  on the trailing edge of the common mode pulse signal ( $V_{\text{CM}}$ ) to assure that the output will remain in a logic low state, i.e.,  $V_O < 0.8 \text{ V}$ .  
 The 1.9 k $\Omega$  load represents 1 TTL unit load of 1.6 mA and the 5.6 k $\Omega$  pull-up resistor.  
 The 4.1 k $\Omega$  load represents 1 LSTTL unit load of 0.36 mA and the 6.1 k $\Omega$  pull-up resistor

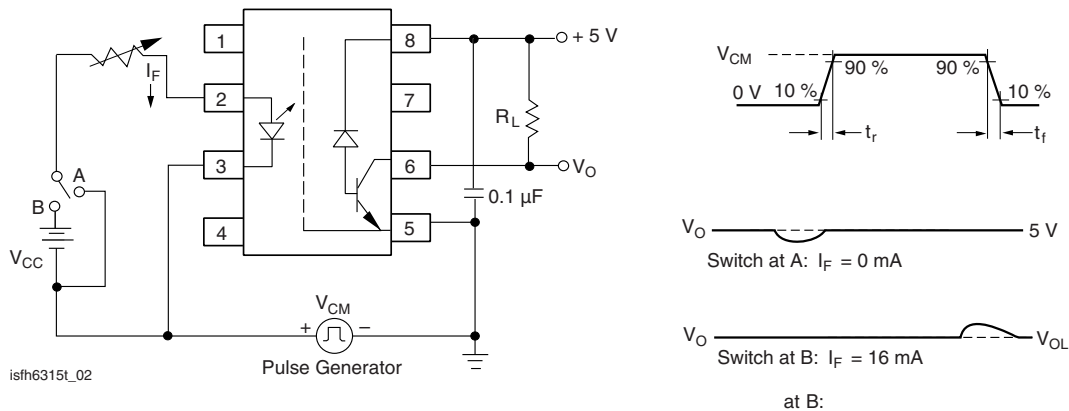


Fig. 4 - Test Circuit for Transient Immunity and Typical Waveforms

<b>SAFETY AND INSULATION RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	MIN.	UNIT
Climatic classification	According to IEC 68 part 1		55 / 100 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	$V_{ISO}$	4000	$V_{RMS}$
Maximum transient isolation voltage	According to DIN EN 60747-5-5	$V_{IOTM}$	6000	$V_{peak}$
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	$V_{IORM}$	560	$V_{peak}$
Isolation resistance	$T_{amb} = 25\text{ }^{\circ}\text{C}$ , $V_{IO} = 500\text{ V}$	$R_{IO}$	$\geq 10^{12}$	$\Omega$
	$T_{amb} = 100\text{ }^{\circ}\text{C}$ , $V_{IO} = 500\text{ V}$	$R_{IO}$	$\geq 10^{11}$	$\Omega$
Output safety power		$P_{SO}$	350	mW
Input safety current		$I_{SI}$	150	mA
Input safety temperature		$T_S$	165	$^{\circ}\text{C}$
Creepage distance	SOIC-8		$\geq 4$	mm
Clearance distance			$\geq 4$	mm
Insulation thickness		DTI	$\geq 0.2$	mm

**Notes**

- As per IEC 60747-5-5, §7.4.3.8.1, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits
- (1) Device considered a two-terminal device: pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

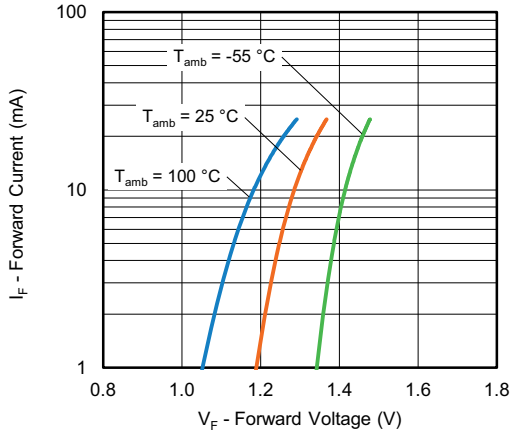


Fig. 5 - Forward Current vs. Forward Voltage

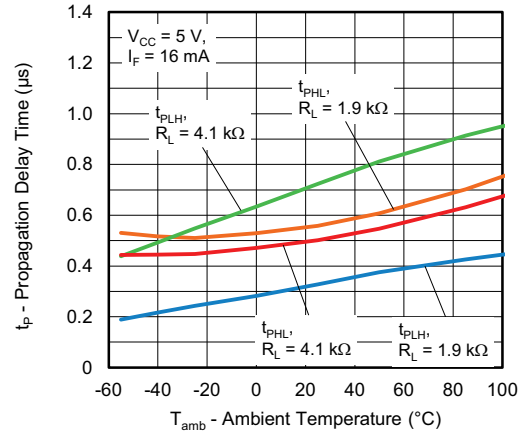


Fig. 8 - Propagation Delay Time vs. Ambient Temperature

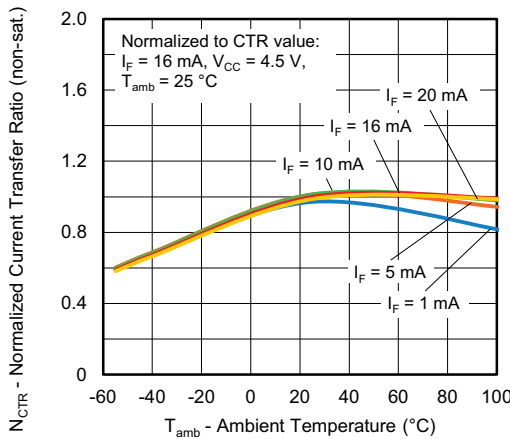


Fig. 6 - Normalized Current Transfer Ratio (non-saturated) vs. Ambient Temperature

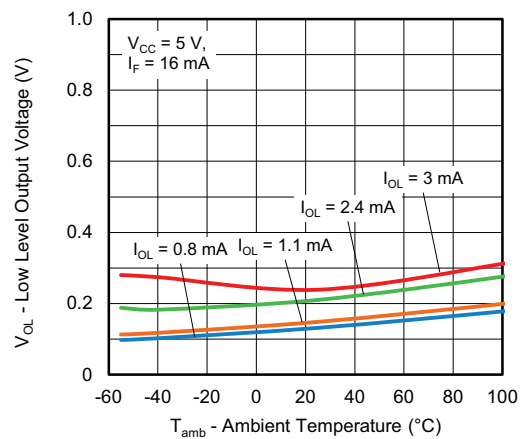


Fig. 9 - Low Level Output Voltage vs. Ambient Temperature

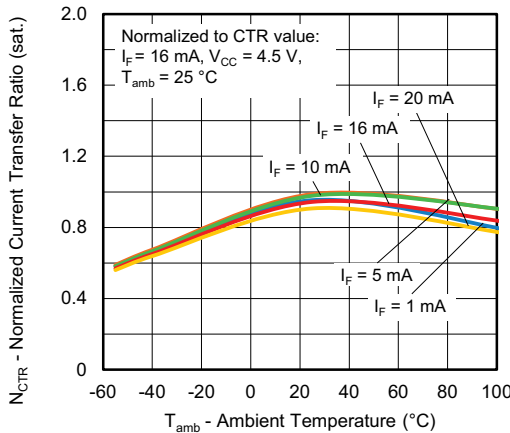


Fig. 7 - Normalized Current Transfer Ratio (saturated) vs. Ambient Temperature



## PACKAGE DIMENSIONS (in millimeters)

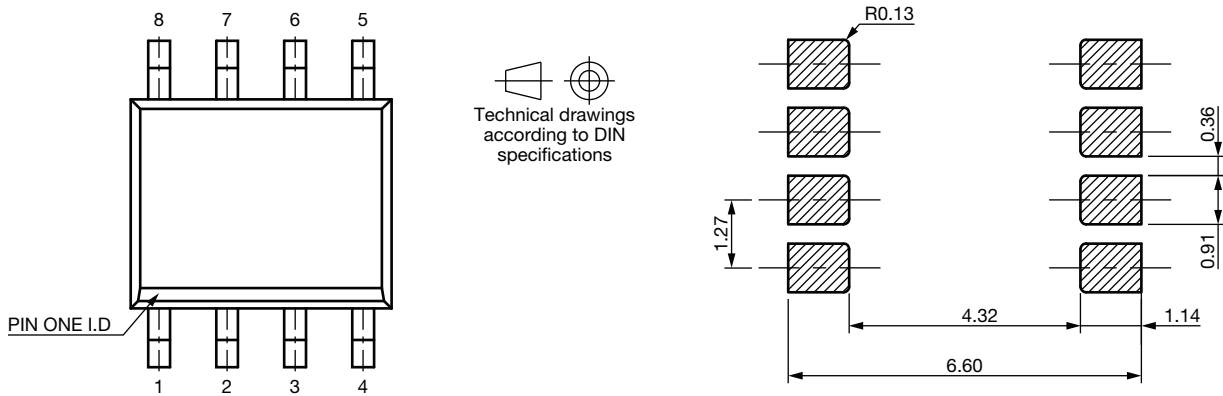
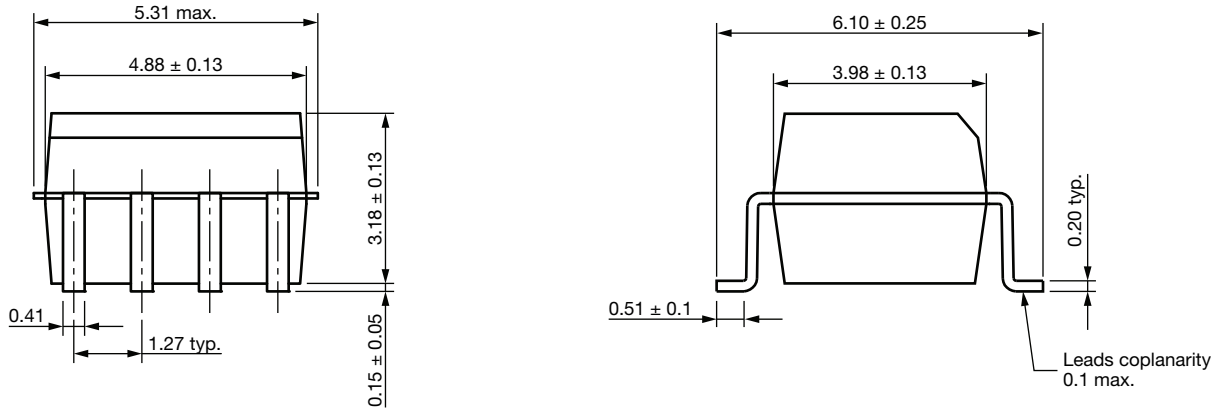


Fig. 10 - Package Drawing

## PACKAGE MARKING

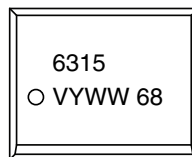


Fig. 11 - Example of SFH6315T

### Notes

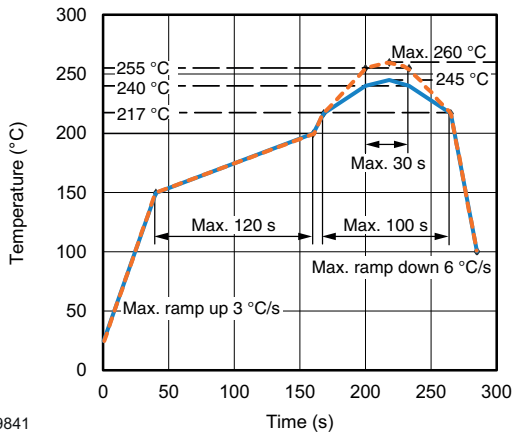
- "YWW" is the date code marking (Y = year code, WW = week code)
- Tape and reel suffix (T) is not part of the package marking







## SOLDER PROFILES



19841

Fig. 14 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

## HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 1C

Floor life: unlimited

Conditions:  $T_{amb} < 30\text{ °C}$ , RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.